

# Tailoring the resonance wavelength and loss of highly Ga doped ZnO plasmonic materials by varied doping content and substrate temperature

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## ABSTRACT

In this paper, Ga-doped ZnO (GZO) thin films are deposited on glass substrates by radio frequency magnetron sputtering for low loss plasmonic applications. The effects of Ga<sub>2</sub>O<sub>3</sub> content in the target and substrate temperature on the electrical, structural and optical properties of GZO films are investigated. Film with the highest carrier concentration of  $7.0 \times 10^{20} \text{ cm}^{-3}$  was obtained at a Ga<sub>2</sub>O<sub>3</sub> content of 5 wt% in the target under room temperature deposition. With increasing deposition temperature, the lowest electrical resistivity of  $3.8 \times 10^{-4} \Omega \text{ cm}$  was acquired at a deposition temperature of 200 °C. The values of plasmonic resonances wavelength could be changed from 1.35 to 2.39  $\mu\text{m}$  by adjusting the carrier concentration. Material absorption losses in these GZO films are 10 times lower than that of conventional Ag films at telecommunication wavelengths. These results make GZO a promising low-loss plasmonic material operating at telecommunication wavelengths.

## Keywords:

Doped zinc oxide  
Gallium doping  
Plasmonic materials  
Magnetron sputtering  
Thin films

## 1. Introduction

The emergence of plasmonic metamaterials opens a new perspective to improve the speed of information processing [1–4]. Metal-based plasmonic materials offer higher speed of information processing than silica fibers at standard operational wavelength [5–7]. Unfortunately, the typical carrier concentrations in metals are too high to push the plasmonic resonance wavelength ( $\lambda_{\text{res}}$ ) to the near-infrared (NIR) spectral range [8–10]. Additionally, metals also suffer from high optical losses at telecommunication wavelength arising in part from intra-band electronic transitions [11–13]. Hence, there is still an urgent requirement in searching better material building blocks to improve the speed of information processing at telecommunication wavelengths.

Recently, the heavily doped semiconductors have been found to exhibit a moderate plasmonic resonance wavelength and a low loss in the mid-infrared and NIR [14–17]. Among these heavily doped semiconductors, Ga doped ZnO (GZO) transparent conducting oxide is a good candidate as plasmonic materials in the NIR due to its high solid solubility and doping efficiency without severe lattice distortion

[16–21]. Moreover, GZO is considered to be more potential to achieve an appropriate concentration to support collective oscillations of free electrons at telecommunication wavelengths [22,23].

Several techniques have been reported in the literature to deposit GZO thin films including pulsed laser deposition [24], chemical vapor deposition [25], atomic layer deposition [26], and radio-frequency magnetron sputtering (RFMS) [27]. Among these deposition techniques, RFMS is quite simple and widely used in industry. In addition, it is possible to produce highly conductive and transparent GZO thin film without heating the substrate, due to the additional energy delivered from the plasma [28].

For the RFMS deposited GZO thin films, the basic fabrication conditions including Ga<sub>2</sub>O<sub>3</sub> doping concentration in GZO ceramic target and MS substrate temperature are the key parameters to affect the film electrical properties, such as carrier concentration, which directly changes the plasmonic resonance wavelength according to the Drude theory [29–36]. Therefore, the adjustment on these basic parameters is necessary to optimize the carrier concentration of GZO film and ensure moderate plasmonic resonance wavelength suitable for plasmonic applications in the NIR. Several studies have been reported about the influence of fabrication parameters on the electrical and optical properties of GZO thin films [28–34]. However, most of these research results do not involve plasmonic resonances wavelength and absorption losses of GZO thin films. Recently, D.C. Look et al. demonstrated that plasmonic resonances wavelength of 1.3 and 1.55  $\mu\text{m}$  in GZO films could be accurately adjusted

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by post-annealing in air [8]. J. Kim et al. also reported that plasmonic resonances wavelength of GZO films could be changed by doping concentrations of 2, 4, 6 wt% and thermal annealing temperatures [35]. Our recent results also showed that plasmonic resonances wavelength in GZO films could be regulated by the inserted Zn layer thickness [36].

Although some methods on regulating plasma resonance wavelength have been reported, it is important to systematically study the effect of doping concentration in the target and substrate temperature on the plasmonic resonance wavelength and absorption losses of GZO films in the NIR range. In this paper, we deposited GZO thin films by RFMS on glass substrate. The effects of the  $\text{Ga}_2\text{O}_3$  content in the target and substrate temperature on the electrical, structural and optical properties of GZO thin films are investigated in detail for the plasmonic material applications at telecommunication wavelengths.

## 2. Experiment

GZO thin films with a thickness of  $\sim 500$  nm were deposited on soda-lime glass substrates by a RFMS apparatus. The GZO targets were the home-made 3-in. ceramic disks. The  $\text{Ga}_2\text{O}_3$  contents in GZO targets were 2 wt%, 3 wt%, 4 wt%, 5 wt%, and 6 wt%, respectively. Prior to deposition, the glass substrates were ultrasonically cleaned in deionized water, followed by acetone solution and alcohol, and then dried in nitrogen. The substrates were placed inside the sputtering chamber and then evacuated to a base pressure of  $5 \times 10^{-4}$  Pa. In order to improve the uniformity of the GZO films, the sample holder rotated at a constant speed of 10 rpm/min.

During deposition, RF power was set at 200 W, Ar gas flow rate was fixed at 30 sccm which was controlled by the mass flow controller, work pressure was set at 0.45 Pa and the deposition time was 30 min. Besides, the substrate temperatures were set at room temperature (unintentional heating), 150 °C, 200 °C, 250 °C and 300 °C, respectively.

The crystalline phase of the films was analyzed by X-ray diffraction (XRD, Bruker, AXS D8 Advance, USA) using a standard  $\theta$ - $2\theta$  geometry diffractometer with Cu K $\alpha$  radiation ( $\lambda = 1.54$  Å). Morphology of the GZO films was observed by a field emission scanning electron microscopy (FESEM, S4800) at an operating voltage of 4 keV. The resistivity, Hall mobility and carrier concentration of the films were analyzed by Hall measurement with the Van der Pauw method (Accent, HL5500PC, UK). The thickness of the coated GZO films was measured by an M-2000DI Ellipsometry (J. A. Woollam) according to the Cauchy model. The complex refractive index and dielectric constants of the films were determined by fitting a Drude + Lorentz oscillator model [35] to the ellipsometry data. The fitting spectral region ranges from 190 nm to 1750 nm. The resonance energy of the Lorentz oscillator is set to 3.7 eV in correspondence to the interband absorption. The amplitude and damping constants of Lorentz oscillator and Drude term and the permittivity  $\epsilon_\infty$  are fit parameters. The optical transmittance and reflection spectrum was obtained by

ultraviolet-visible-NIR spectrophotometer (PerkinElmer, LAMBDA950). The absorption spectrum was calculated by the formula: Absorption + Transmission + Reflection = 100%. The measuring spectral region ranges from 250 nm to 2500 nm.

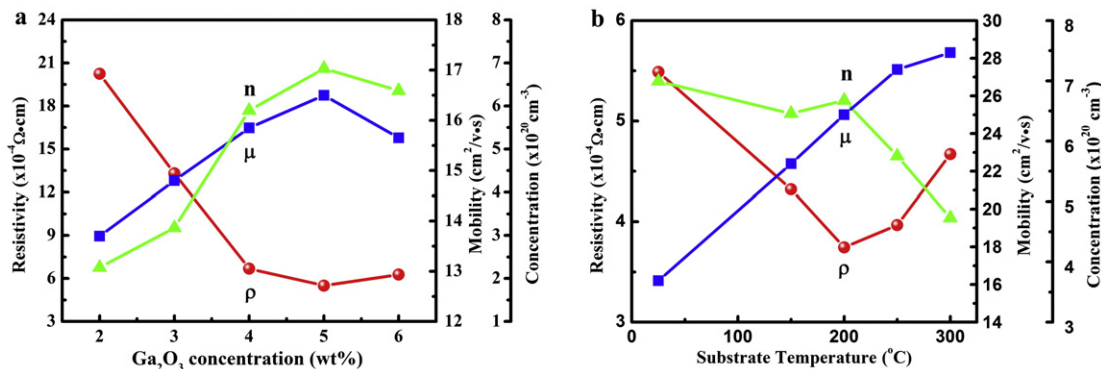
## 3. Results and discussion

### 3.1. Electrical properties

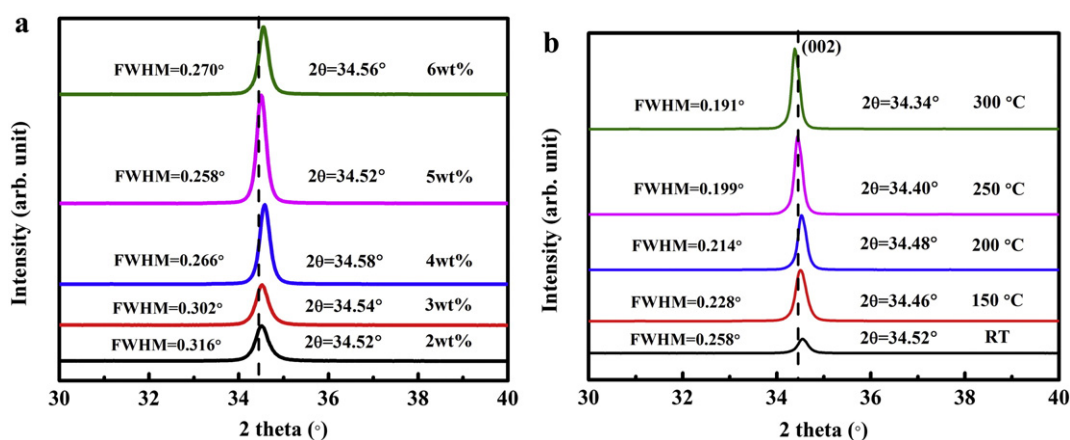
The electrical properties of the GZO thin films intensively depend on the fabrication parameters of  $\text{Ga}_2\text{O}_3$  content in the target and substrate temperature [37–40]. Fig. 1a shows the variation of resistivity ( $\rho$ ), carrier density ( $n$ ), and Hall mobility ( $\mu$ ) as a function of  $\text{Ga}_2\text{O}_3$  content ( $N_g$ ) in the target for GZO films grown at room temperature (RT). The lower resistivity GZO films ( $5 \sim 6 \times 10^{-4} \Omega \text{ cm}$ ) can be obtained at  $N_g$  from 4 to 6 wt%. It can be attributed to the substitution of Ga elements into Zn site [39], since the  $\text{Ga}_{\text{Zn}}$  defects are the main donor defects contributing to the enhancement of  $n$ -type conductive [41]. As the  $N_g$  increased from 2 wt% to 5 wt%, the correspondingly increased donor defects lead to an enhancement of carrier concentration and a decrease in resistivity. The highest carrier concentration reached  $7 \times 10^{20} \text{ cm}^{-3}$  for the film with a  $N_g$  of 5 wt%, and then slightly decreased to  $6.4 \times 10^{20} \text{ cm}^{-3}$  at  $N_g$  of 6 wt%. It can be deduced that Ga has a higher doping efficiency and solid solubility in ZnO system, and the optimized  $N_g$  is 5 wt%. Fig. 1b shows the electrical properties of GZO films with  $N_g$  of 5 wt% in the target as a function of substrate deposition temperature ( $T_s$ ). As the  $T_s$  increased from RT to 200 °C, the resistivity decreased from  $5.5 \times 10^{-4}$  to a minimum value of  $3.7 \times 10^{-4} \Omega \text{ cm}$ . This decrease originates from the increased carrier mobility, which can be attributed to an increase in the grain size of the GZO film with increasing  $T_s$  to reduce the grain boundary scattering [38,40]. As  $T_s$  is further increased from 200 to 300 °C, an increase in the resistivity is observed as a combination of a decrease in carrier density from  $6.87 \times 10^{20}$  to  $4.09 \times 10^{20} \text{ cm}^{-3}$  and a slight increase in the Hall mobility from 25.2 to  $28.3 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$ . The segregation of  $\text{Ga}_2\text{O}_3$  at the grain boundaries in the films is responsible for the increase of resistivity when substrate temperature exceeds 200 °C [42]. Hence, the GZO film with highest carrier concentration can be obtained at  $N_g$  of 5 wt% and  $T_s$  of RT.

### 3.2. Structural properties

To investigate the crystalline structural properties of GZO films, X-ray diffraction measurement is employed and shown in Fig. 2. All the films exhibit preferential growth with a strong diffraction peak at  $2\theta = \sim 34.4^\circ$ , which is originated from ZnO (002) planes (JCPDS No. 36-1451), indicating typical hexagonal wurtzite structure with  $c$ -axis preferred orientation. Fig. 2a shows the XRD patterns of GZO films



**Fig. 1.** Resistivity ( $\rho$ ), carrier density ( $n$ ), and Hall mobility ( $\mu$ ) of GZO films grown (a) at RT using the sputtering targets with various  $\text{Ga}_2\text{O}_3$  doping contents (2, 3, 4, 5 and 6 wt%), and (b) at various substrate temperatures (RT, 150, 200, 250 and 300 °C) using the sputtering target with a  $\text{Ga}_2\text{O}_3$  doping content of 5 wt%. The film thickness was  $\sim 500$  nm.

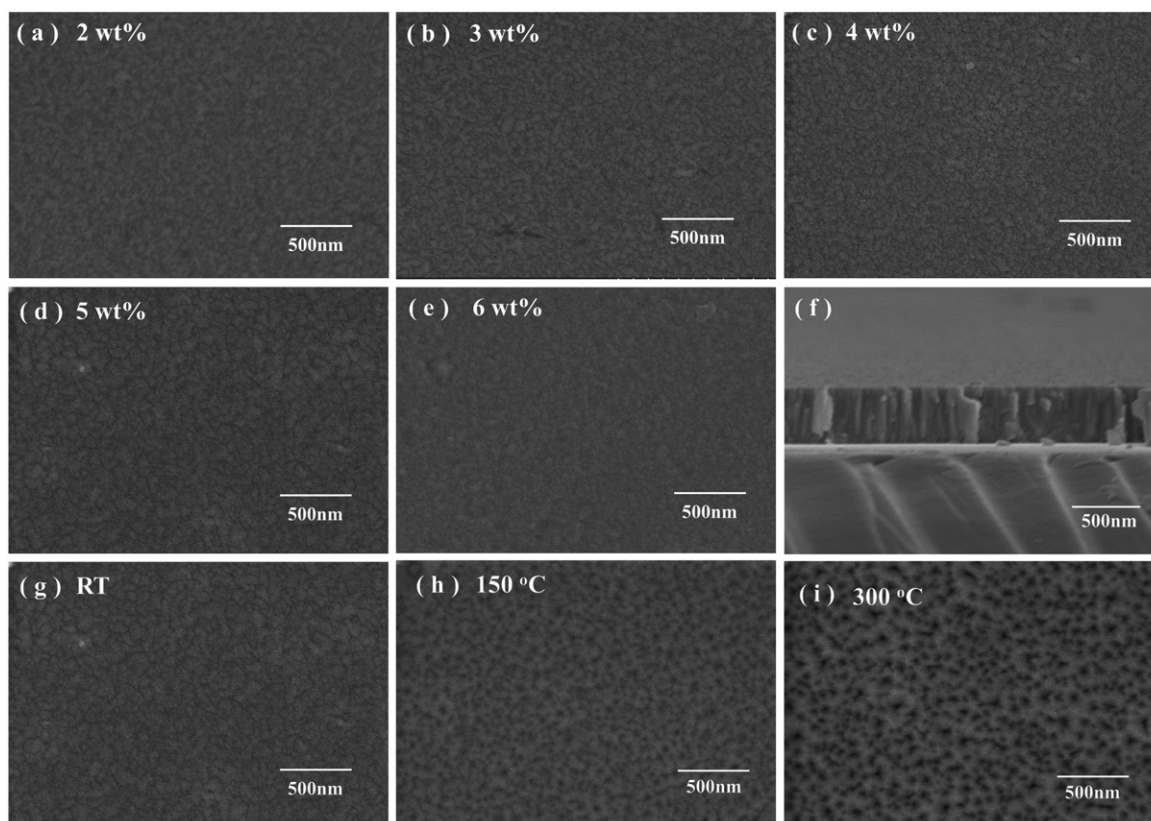


**Fig. 2.** XRD patterns of GZO films grown (a) at RT using the sputtering targets with various Ga<sub>2</sub>O<sub>3</sub> doping contents (2, 3, 4, 5 and 6 wt%), and (b) at various substrate temperatures (RT, 150, 200, 250 and 300 °C) using the sputtering target with a Ga<sub>2</sub>O<sub>3</sub> doping content of 5 wt%.

deposited at RT with different Ng. As the Ng increases from 2 wt% to 4 wt%, the (002) 2θ diffraction angles move from 34.52° to 34.58°. Noting that the radius of Ga<sup>3+</sup> ion (0.62 Å) is smaller than that of Zn<sup>2+</sup> ion (0.72 Å), the substitution of Ga<sup>3+</sup> to Zn<sup>2+</sup> leads to the decrease of the c-axis lattice parameter. Based on Bragg diffraction formula, the decrease of c-axis lattice parameter results in the increase of (002) diffraction angles. As the Ng is further increased from 4 wt% to 5 wt%, the position of (002) peak declines slightly. It may be due to the existence of gallium interstitial (Ga<sub>i</sub>) [43]. When the Ng reaches 6 wt%, the position of (002) peak increases slightly due to the existence of small amount of Ga<sub>2</sub>O<sub>3</sub> derived from limited solid solubility and doping efficiency. Fig. 2b shows the XRD patterns of GZO films with Ng of 5 wt% deposited at different Ts. It can be seen that the intensities

of (002) peaks obviously increase as the Ts increasing from RT to 300 °C. It means that the crystalline quality of the samples has an obvious improvement, furthermore enhancing the Hall mobility. As the Ts increases, the position of (002) peaks shift to lower 2θ values, indicating that the c-axis lattice parameter increases with growth temperature. It could be explained by the decrease of the number of substitutional Ga<sup>3+</sup> ions into Zn<sup>2+</sup> sites as increasing TS, especially at the temperature higher than 200 °C [39]. The grain size can be calculated from the full width at half maximum of the (002) diffraction peak by using the Scherrer formula [44], and the corresponding grain sizes of all films are in the range of 35 to 51 nm.

Fig. 3 shows the surface and cross-sectional view of SEM micrographs deposited at various Ng and Ts. Fig. 3a–e shows the surface



**Fig. 3.** Surface morphologies of GZO thin films. (a) 2 wt% (RT), (b) 3 wt% (RT), (c) 4 wt% (RT), (d) 5 wt% (RT), (e) 6 wt% (RT), (g) 5 wt% (RT), (h) 5 wt% (150 °C), (i) 5 wt% (300 °C). Cross section of GZO film deposited at RT. (f) 5 wt% (RT). The scale bar is 500 nm.



micrographs of GZO thin films deposited at various Ng. There is no obvious variation except the average size of grains. Fig. 3g–i shows the surface micrographs of GZO thin films deposited at various Ts. The surface of GZO thin films deposited at RT is extremely uniform. Nevertheless, GZO thin film grown above 150 °C shows a rougher surface morphology with many small pits. The substituted Ga atoms in ZnO affect the growth behavior of thin films. The cross sectional view of 5 wt% GZO film deposited at RT is shown in Fig. 3f. The high compact structure shows a typically dense columnar growth, as shown in literature [38].

### 3.3. Optical properties

The optical transmittances as a function of the wavelength for the GZO films deposited at different Ng and Ts are shown in Fig. 4a and c, respectively. The average transmittances of all films are above 85% in the wavelength range of 400–800 nm. The near-infrared transmittances decrease with the increase of Ng (Fig. 4a) and the decrease of Ts (Fig. 4c). These changes of the optical properties originated directly from the increase of the carrier concentration, which leads to a lower value associated to the plasma wavelength [45]. Fig. 4b and d shows absorption spectra for the GZO films deposited at different Ng and Ts, respectively. Due to the plasma oscillation, the maximum absorption peak occurs at the characteristic plasma wavelength,  $\lambda_p$  [46]. As the Ts decreases,  $\lambda_p$  shifts to shorter wavelengths, which can be attributed to the change of carrier concentration [8].

Fig. 5 shows the variation of  $n$ , measured  $\lambda_p$  and calculated  $\lambda_p$  as a function of Ng and Ts for the GZO films. Both of the  $\lambda_p$  are inversely

related to  $n$  in the GZO films. This behavior can be expressed by the

$$\text{equation: } \lambda_p = \sqrt{\frac{4^2 c^2 m^* \epsilon_0 \epsilon_\infty}{Ne^2}}$$

where  $c$  is the speed of light in a vacuum,  $\epsilon_\infty$  is the high-frequency dielectric constant,  $\epsilon_0$  is the permittivity of free space,  $m^*$  is the effective mass of electrons,  $N$  is the carrier concentration and  $e$  is the electron charge. Taking  $\epsilon_\infty$  at infinity as 4 and  $m^*$  as 0.3 [42],  $N$  is obtained from the Hall measurements, calculated  $\lambda_p$  can be estimated from the equation above. The estimated  $\lambda_p$  in Fig. 5a is in the range of 1384–2413 nm for samples with various Ng. The estimated  $\lambda_p$  in Fig. 5b is in the range of 1384–1630 nm for samples with different Ts. The measured  $\lambda_p$  can be obtained from the maximum absorption peak in Fig. 4b and d, where  $\lambda_p$  are found to range from 1375 to 2385 nm and 1375 to 1630 nm, respectively. It is obviously found that these measured data are in good agreement with the calculated data. Thus, the plasmonic resonance wavelength for GZO films can be accurately tuned by varying the carrier density introduced by the Ng and Ts.

To demonstrate the GZO thin films as an alternative plasmonic metamaterials, we obtained the complex refractive indexes and dielectric constants of the films by fitting a Drude + Lorentz oscillator model [35] to the ellipsometry data. The following equation describes the Drude–Lorentz oscillator model.

$$\epsilon(\omega) = \epsilon_\infty - \frac{\omega_p^2}{\omega(\omega + i\Gamma_p)} + \frac{f_l \omega_l^2}{\omega_l^2 - \omega^2 - i\omega\Gamma_l}$$

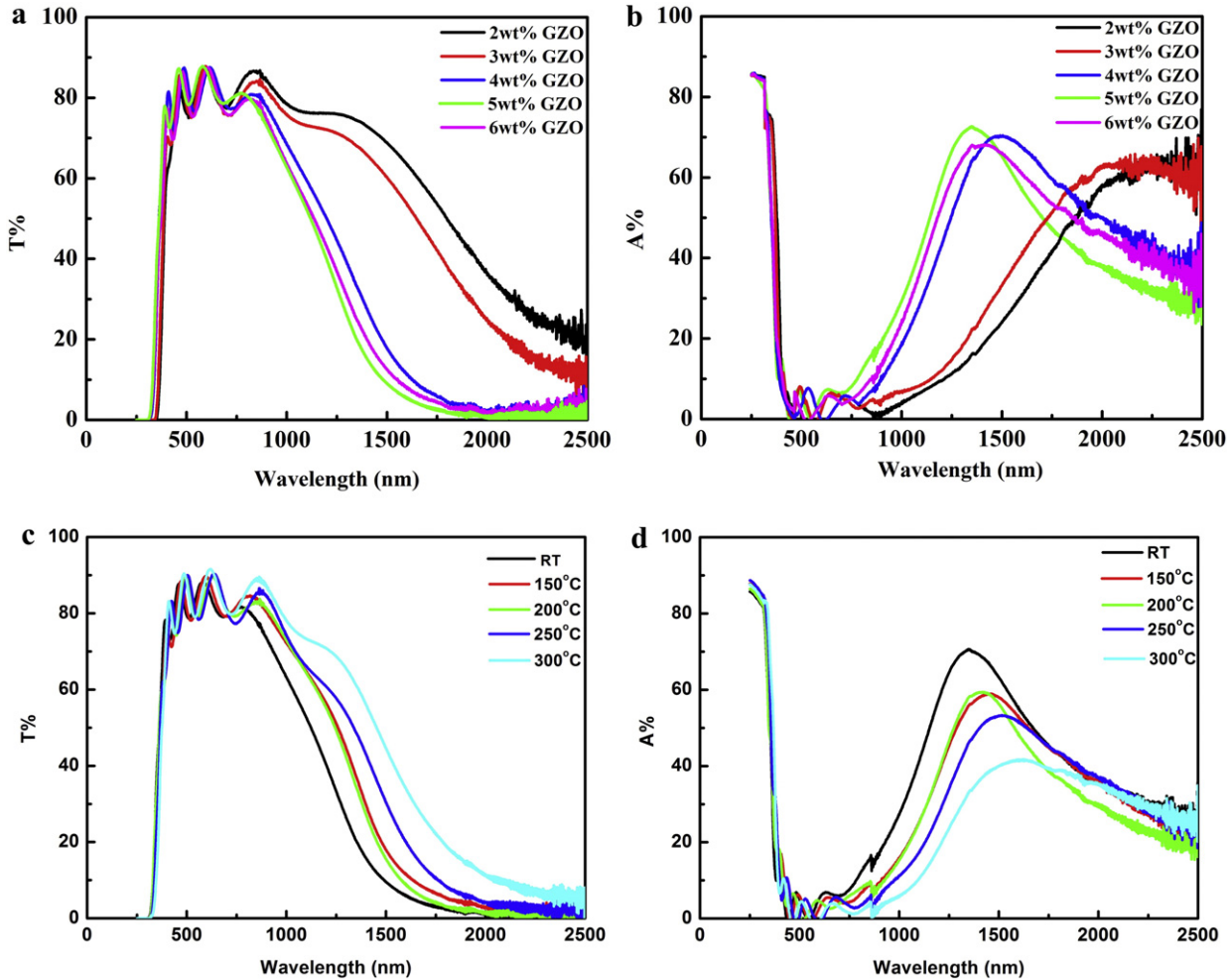
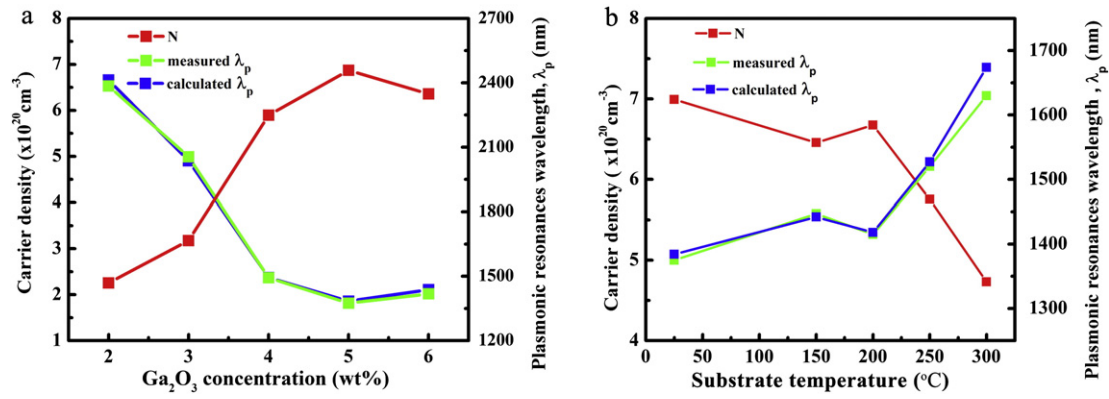


Fig. 4. Optical transmittance and optical absorption of GZO films grown (a), (b) at RT using the sputtering targets with various Ga<sub>2</sub>O<sub>3</sub> doping contents (2, 3, 4, 5 and 6 wt%), and (c), (d) at various substrate temperatures (RT, 150, 200, 250 and 300 °C) using the sputtering target with a Ga<sub>2</sub>O<sub>3</sub> doping content of 5 wt%.



**Fig. 5.** Carrier concentration ( $n$ ) and the plasma wavelength ( $\lambda_p$ ) for GZO thin films grown (a) at RT using the sputtering targets with various  $\text{Ga}_2\text{O}_3$  doping contents (2, 3, 4, 5 and 6 wt%), and (b) at various substrate temperatures (RT, 150, 200, 250 and 300 °C) using the sputtering target with a  $\text{Ga}_2\text{O}_3$  doping content of 5 wt%.

where  $\epsilon_\infty$  is the background permittivity,  $\omega_p$  is the plasma frequency,  $\Gamma_p$  is the carrier relaxation rate, and  $f_l$  is the strength of the Lorentz oscillator with center frequency  $\omega_l$  and damping  $\Gamma_l$ . The Lorentz oscillator model is suitable for ultraviolet band. The Drude model is suitable for visible and near-infrared wave band.

Fig. 6 shows the SE parameters  $\Delta$  and  $\Psi$  of a GZO thin film (ceramic target with 5 wt%  $\text{Ga}_2\text{O}_3$ , deposited at room temperature) on glass measured for angle of incidence (AOI = 75°). Red line shows fit to the data using a model for the dielectric function of the GZO thin film. The mean square error is MSE ~ 6.1 for a fit over the whole wavelength range.

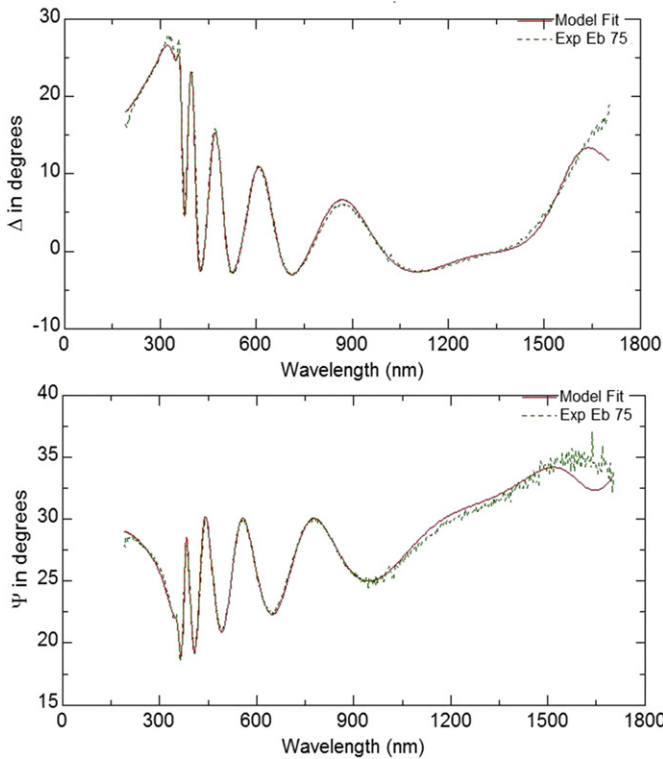
Fig. 7a and c shows the real parts of the permittivity of the GZO films as a function of  $N_g$  and  $T_s$ . The zero-cross-over of the real permittivity (defined as the wavelength at which the real part of the permittivity ( $\epsilon_1$ ) crosses zero) is observed to shift toward shorter wavelength due

to the increased carrier concentration as  $N_g$  increases and  $T_s$  decreases respectively. The negative real permittivity at 1.55  $\mu\text{m}$  guarantees Drude metal-like optical properties at telecommunication wavelengths, which is a necessary condition to be used as building blocks in the field of plasmonic metamaterial devices [47]. However, increasing the carrier concentration also leads to increased losses at the NIR range [11]. To compare the absorption of GZO films with metal materials, the ratios  $n/k$  with  $n$  and  $k$  being the real and imaginary parts of the refractive index of the GZO films deposited at different  $N_g$  and  $T_s$  are plotted in Fig. 7b and d. The larger ratio of  $n/k$  corresponds to less material absorption losses [48]. Although the absorption losses of GZO film increase as carrier concentration increases, the lowest ratio of all samples is also ten times larger than silver at the telecommunication wavelengths of 1.55  $\mu\text{m}$  (Fig. 7b and d). Thus, the value of carrier concentration in GZO thin film is the dominating factor that determines the film from reaching the ideal.

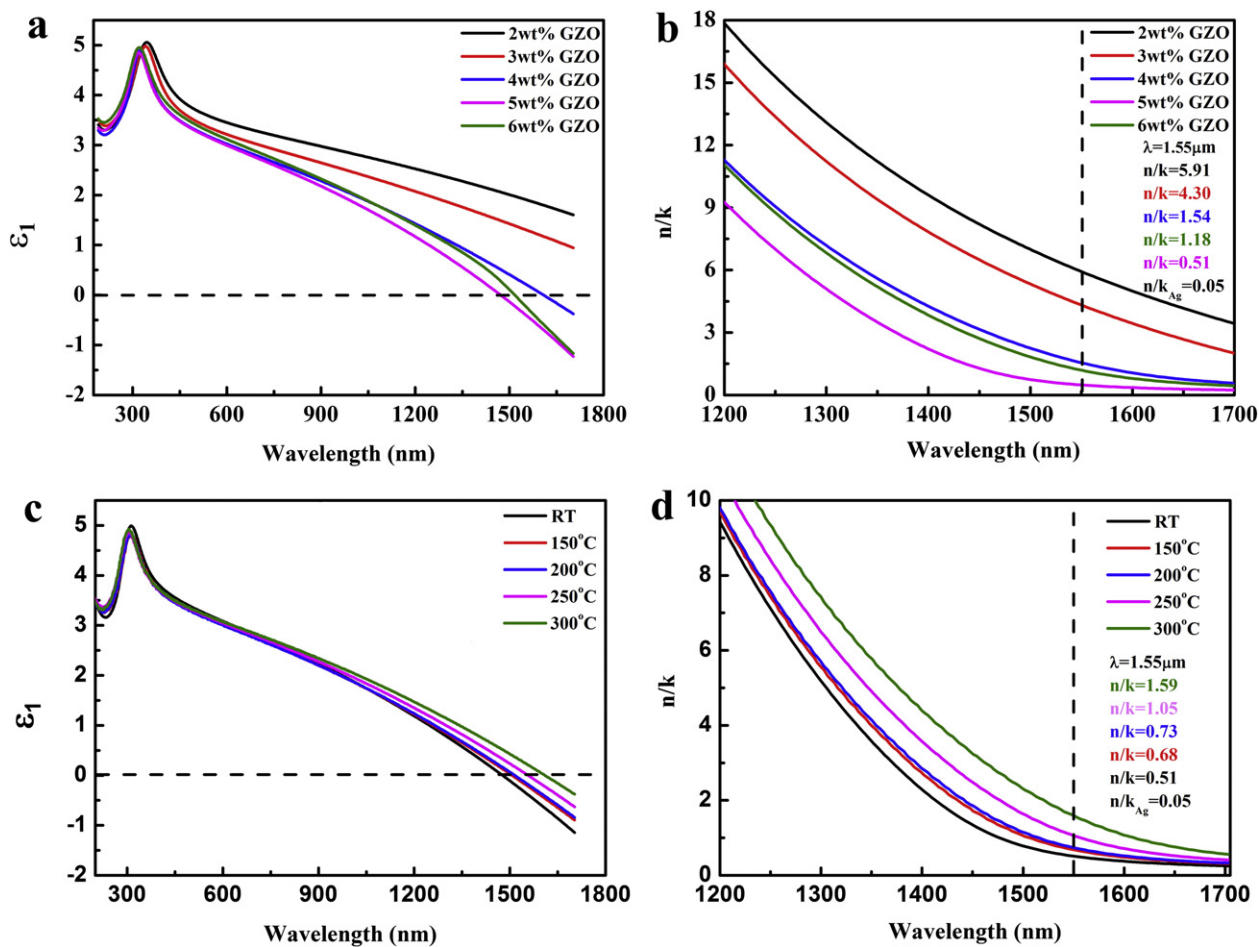
Fig. 8 shows the influences of target concentration and substrate temperature on tuning the GZO properties. There are three groups of histogram in Fig. 8. The first group represents the ratio of the adjustable extent of carrier concentration stem from varied target  $\text{Ga}_2\text{O}_3$  concentration to that stem from varied temperature. The second group represents the ratio of the adjustable extent of plasmonic resonances wavelength stem from varied target  $\text{Ga}_2\text{O}_3$  concentration to that stem from varied temperature. The third group represents the ratio of the adjustable extent of material absorption losses at 1.55  $\mu\text{m}$  stem from varied target  $\text{Ga}_2\text{O}_3$  concentration to that stem from varied temperature. The front column represents the ratio from target  $\text{Ga}_2\text{O}_3$  concentration in each group. The later column represents the ratio from temperature in each group. Obviously, target  $\text{Ga}_2\text{O}_3$  concentration has the most dominating influence on tuning the GZO properties.

#### 4. Conclusions

In summary, the effects of  $\text{Ga}_2\text{O}_3$  content in the target and substrate temperature on the electrical, structural and optical properties of GZO films deposited on glass substrates by RF magnetron sputtering are investigated. The  $N_g$  and  $T_s$  during deposition of these films have been optimized to achieve the highest possible carrier concentration and mobility. Enhancing the  $N_g$  increased the carrier concentration due to the increased number of substitution Ga. It is found that the film deposited at optimized conditions ( $N_g = 5$  wt%,  $T_s = \text{RT}$ ) has the highest carrier concentration of  $7.0 \times 10^{20} \text{ cm}^{-3}$ . Correspondingly, the real part of the permittivity of the GZO film is negative at 1.55  $\mu\text{m}$ , which is a necessary condition to be an ideal plasmonic metamaterials. In addition, the values of plasmonic resonances wavelength can be changed from 1.35 to 2.39  $\mu\text{m}$  by adjusting the carrier concentration. Absorption



**Fig. 6.** Spectroscopic ellipsometric parameters  $\Delta$  and  $\Psi$  of a GZO thin film (ceramic target with 5 wt%  $\text{Ga}_2\text{O}_3$ , deposited at room temperature) on glass measured for angle of incidence (AOI = 75°).



**Fig. 7.** Real parts of permittivity and the ratios  $n/k$  with  $n$  and  $k$  being the real and imaginary parts of the refractive index of the GZO film deposited (a), (b) at RT using the sputtering targets with various Ga<sub>2</sub>O<sub>3</sub> doping contents (2, 3, 4, 5 and 6 wt%), and (c), (d) at various substrate temperatures (RT, 150, 200, 250 and 300 °C) using the sputtering target with a Ga<sub>2</sub>O<sub>3</sub> doping content of 5 wt%.

losses in these GZO films are less 10 times smaller than those observed in conventional Ag films at the telecommunication wavelengths of 1.55  $\mu\text{m}$ . These results show that the value of carrier concentration is the dominating factor that affected GZO films become a promising low-loss alternative material to conventional metals for plasmonic application at telecommunication wavelength.

## Acknowledgements

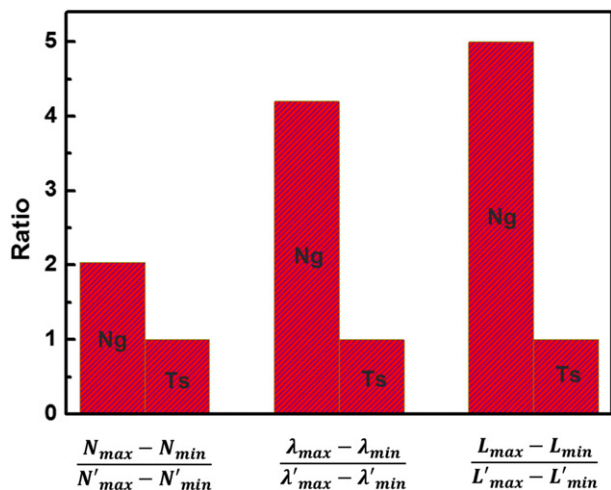
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## Appendix A. Supplementary data

Supplementary data to this article can be found online at <http://dx.doi.org/10.1016/j.tsf.2015.11.005>.

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**Fig. 8.** The ratios of the adjustable extent of the GZO properties from target Ga<sub>2</sub>O<sub>3</sub> concentration to that from temperature.



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